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Understanding Embedded - Microprocessors

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of **Embedded - Microprocessors**

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details

Details	
Product Status	Active
Core Processor	-
Number of Cores/Bus Width	-
Speed	-
Co-Processors/DSP	-
RAM Controllers	-
Graphics Acceleration	-
Display & Interface Controllers	-
Ethernet	-
SATA	-
USB	-
Voltage - I/O	-
Operating Temperature	-
Security Features	-
Package / Case	-
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=t4160nsn7qtb

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2 Summary of benefits

The T4 family of processors are ideal for combined control and data plane processing. A wide variety of applications can benefit from the processing, I/O integration, and power management capabilities. Similar to other QorIQ devices, the T4 family of processors' high level of integration offers significant space, weight, and power benefits compared to multiple discrete devices. Examples include:

- Service provider networking: RNC, metro networking, gateway, core/edge router, EPC, CRAN, ATCA, and AMC solutions.
- Enterprise equipment: router, switch services, and UTM appliances.
- Data centers: NFV, SDN, ADC, WOC, UTM, proxy, server appliance, and PCI Express (PCIe) offload.
- Storage controllers: FCoE bridging, iSCSI controller, and SAN controller.
- Aerospace, defense, and government: radar imaging, ruggedized network appliance, and cockpit display.
- Industrial computing: single-board computers and test equipment.

2.1 e6500 CPU core

The T4 family of processors are based on the Power Architecture® e6500 core. The e6500 core uses a seven-stage pipeline for low latency response while also boosting single-threaded performance. The e6500 core also offers high aggregate instructions per clock at lower power with an innovative "fused core" approach to threading. The e6500 core's fully resourced dual threads provide 1.7 times the performance of a single thread.

The e6500 cores are clustered in banks of four cores sharing a 2 MB L2 cache, allowing efficient sharing of code and data within a multicore cluster. Each e6500 core implements the Freescale AltiVec technology SIMD engine, dramatically boosting performance of heavy math algorithms with DSP-like performance.

The e6500 core features include:

- Up to 1.8 GHz dual threaded operation
- 7 DMIPS/MHz per core
- · Advanced power saving modes, including state retention power gating

2.2 Virtualization

The T4 family of processors includes support for hardware-assisted virtualization. The e6500 core offers an extra core privilege level (hypervisor) and hardware offload of logical-to-real address translation. In addition, the T4 family of processors includes platform-level enhancements supporting I/O virtualization with DMA memory protection through IOMMUs and configurable "storage profiles" that provide isolation of I/O buffers between guest environments. Virtualization software for the T4 family includes kernel virtualization machine (KVM), Linux containers, and Freescale hypervisor and commercial virtualization software from vendors such as Enea®, Greenhills Software®, Mentor Graphics®, and Wind River.

2.3 Data Path Acceleration Architecture (DPAA)

The T4 family of processors enhance the QorIQ DPAA, an innovative multicore infrastructure for scheduling work to cores (phyiscal and virtual), hardware accelerators, and network interfaces.



The Frame Manager (FMAN), a primary element of the DPAA, parses headers from incoming packets and classifies and selects data buffers with optional policing and congestion management. The FMAN passes its work to the Queue Manager (QMAN), which assigns it to cores or accelerators with a multilevel scheduling hierarchy. The T4240 processor's implementation of the DPAA offers accelerations for cryptography, enhanced regular expression pattern matching, and compression/decompression.

2.4 System peripherals and networking

For networking, there are dual FMANs with an aggregate of up to 16 any-speed MAC controllers that connect to PHYs, switches, and backplanes over RGMII, SGMII, QSGMII, HiGig2, XAUI, XFI, and 10Gbase-KR. The FMAN also supports new quality of service features through egress traffic shaping and priority flow control for data center bridging in converged data center networking applications. High-speed system expansion is supported through four PCI Express controllers that support varieties of lane lengths for PCIe specification 3.0, including endpoint SR-IOV with 128 virtual functions. Other peripherals include:

- SRIO
- Interlaken-LA
- SATA
- SD/MMC
- I²C
- UART
- SPI
- NOR/NAND controller
- GPIO
- 1866 MT/s DDR3/L controller

3 Application examples

This chip is well-suited for applications that are highly compute-intensive, I/O-intensive, or both.

3.1 1U security appliance

This figure shows a 1U security appliance built around a single SoC. The QorIQ DPAA accelerates basic packet classification, filtering, and packet queuing, while the crypto accelerator (SEC 5.0), regex accelerator (PME 2.1), and compression/decompression accelerator (DCE 1.0) perform high throughput content processing. The high single threaded and aggregate DMIPS of the core CPUs provide the processing horsepower for complex classification and flow state tracking required for proxying applications as well as heuristic traffic analysis and policy enforcement.

The SoC's massive integration significantly reduces system BOM cost. SATA hard drives connect directly to the SoC's integrated controllers, and an Ethernet switch is only required if more than 16 1 GE ports or 4 10 GE ports are required. The SoC supports PCIe and Serial RapidIO for expansion.



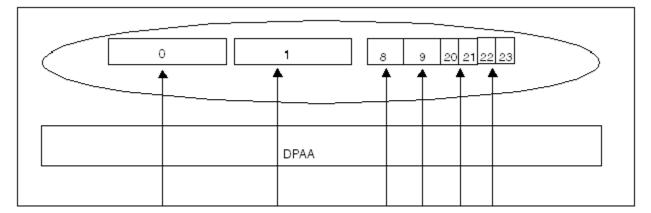


Figure 7. Mixed SMP and AMP option 2

5 Chip features

This section describes the key features and functionalities of the T4240 chip. See the T4160 and T4080 appendices for those device's specific block diagrams.

5.1 Block diagram

This figure shows the major functional units within the chip.



Crip features

This table shows the computing metrics the core supports.

Table 2. Power architecture metrics

Metric	Per core	Per cluster	Full device
DMIPS	10,800	43,200	129,600
Single-precision GFLOPs	18	72	Up to 216
Double-precision GFLOPs	3.6	14.4	Up to 42.4

The core subsystem includes the following features:

- Up to 1.8 GHz
- Dual-thread with simultaneous multi-threading (SMT)
 - Threading can be disabled on a per CPU basis
- 40-bit physical addressing
- L2 MMU
 - Supporting 4 KB pages
 - TLB0; 8-way set-associative, 1024-entries (4 KB pages)
 - TLB1; fully associative, 64-entry, supporting variable size pages and indirect page table entries
- Hardware page table walk
- 64-byte cache line size
- L1 caches, running at core frequency
 - 32 KB instruction, 8-way set-associative
 - 32 KB data, 8-way set-associative
 - Each with data and tag parity protection
- Hardware support for memory coherency
- Five integer units: 4 simple (2 per thread), 1 complex (integer multiply and divide)
- Two load-store units: one per thread
- Classic double-precision floating-point unit
 - Uses 32 64-bit floating-point registers (FPRs) for scalar single- and double-precision floating-point arithmetic
 - Designed to comply with IEEE Std. 754[™]-1985 FPU for both single and double-precision operations
- AltiVec unit
 - 128-bit Vector SIMD engine
 - 32 128-bit VR registers
 - Operates on a vector of
 - Four 32-bit integers
 - Four 32-bit single precision floating-point units
 - Eight 16-bit integers
 - Sixteen 8-bit integers
 - Powerful permute unit
 - Enhancements include: Move from GPRs to VR, sum of absolute differences operation, extended support for misaligned vectors, handling head and tails of vectors
- Supports Data Path Acceleration Architecture (DPAA) data and context "stashing" into L1 and L2 caches
- User, supervisor, and hypervisor instruction level privileges
- Addition of Elemental Barriers and "wait on reservation" instructions
- New power-saving modes including "drowsy core" with state retention and nap
 - State retention power-saving mode allows core to quickly wake up and respond to service requests
- Processor facilities
 - Hypervisor APU
 - "Decorated Storage" APU for improved statistics support
 - Provides additional atomic operations, including a "fire-and-forget" atomic update of up to two 64-bit quantities by a single access
 - Addition of Logical to Real Address translation mechanism (LRAT) to accelerate hypervisor performance
 - Expanded interrupt model



5.6 CoreNet fabric and address map

The CoreNet fabric provides the following:

- A highly concurrent, fully cache coherent, multi-ported fabric
- Point-to-point connectivity with flexible protocol architecture allows for pipelined interconnection between CPUs, platform caches, memory controllers, and I/O and accelerators at up to 733 MHz
- The CoreNet fabric has been designed to overcome bottlenecks associated with shared bus architectures, particularly address issue and data bandwidth limitations. The chip's multiple, parallel address paths allow for high address bandwidth, which is a key performance indicator for large coherent multicore processors.
- Eliminates address retries, triggered by CPUs being unable to snoop within the narrow snooping window of a shared bus. This results in the chip having lower average memory latency.

This chip's 40-bit, physical address map consists of local space and external address space. For the local address map, 32 local access windows (LAWs) define mapping within the local 40-bit (1 TB) address space. Inbound and outbound translation windows can map the chip into a larger system address space such as the RapidIO or PCIe 64-bit address environment. This functionality is included in the address translation and mapping units (ATMUs).

5.7 Memory complex

The SoC's memory complex consists of up to three DDR controllers for main memory, and the memory controllers associated with the Integrated Flash Controller (IFC).

5.7.1 DDR memory controllers

The chip offers up to three 64-bit DDR controllers supporting ECC protected memories. These DDR controllers operate at up to 1.867 GT/s for DDR3, and, in more power sensitive applications, up to 1.6 GHz for DDR3L. Some key DDR controller features are as follows:

- Interleaving options
 - None, three fully independent controllers
 - · Two interleaved, one independent
 - Three interleaved
 - Interleaving can be configured on 1 KB, 4 KB, and 8 KB granules
- Support x4, x8, and x16 memory widths
 - Programmable support for single, dual, and quad ranked devices and modules
 - · Support for both unbuffered and registered DIMMs
 - 4 chip-selects per controller
 - 64 GB per controller, 192 GB per chip
- The SoC can be configured to retain the currently active SDRAM page for pipelined burst accesses. Page mode support of up to 64 simultaneously open pages can dramatically reduce access latencies for page hits. Depending on the memory system design and timing parameters, page mode can save up to ten memory clock cycles for subsequent burst accesses that hit in an active page.
- Using ECC, the SoC detects and corrects all single-bit errors and detects all double-bit errors and all errors within a nibble.
- Upon detection of a loss of power signal from external logic, the DDR controllers can put compliant DDR SDRAM DIMMs into self-refresh mode, allowing systems to implement battery-backed main memory protection.
- In addition, the DDR controllers offer an initialization bypass feature for use by system designers to prevent reinitialization of main memory during system power-on after an abnormal shutdown.
- Support active zeroization of system memory upon detection of a user-defined security violation.



- Supports external SD bus voltage selection by register configuration
- Host will send 80 idle SD clock cycles to card, which are needed during card power-up, if bit INITA in the system control register (SYSCTL) is set

5.8 Universal serial bus (USB) 2.0

The two USB 2.0 controllers with integrated PHY provide point-to-point connectivity that complies with the USB specification, Rev. 2.0. Each of the USB controllers with integrated PHY can be configured to operate as a stand-alone host, and one of the controllers (USB #2) can be configured as a stand-alone device, or with both host and device functions operating simultaneously.

5.9 High-speed peripheral interface complex (HSSI)

This chip offers a variety of high-speed serial interfaces, sharing a set of 16 SerDes lanes. Each interface is backed by a high speed serial interface controller. This chip has the following types and quantities of controllers:

- Four 2.0 PCI Express controllers, two supporting 3.0
- Two Serial RapidIO 2.0
- Two SATA 2.0
- One Interlaken look-aside
- Aurora
- · Up to sixteen Ethernet controllers with various protocols

5.9.1 PCI Express

Each of the chip's PCI Express controllers is compliant with the PCI Express Base Specification Revision 2.0. Two are additionally compliant with Revision 3.0 (8 GHz). Key features of each PCI Express controller include the following:

- Power-on reset configuration options allow root complex or endpoint functionality.
- The physical layer operates at 2.5, 5, or 8 Gbaud data rate per lane.
- x4, x2, and x1 link widths supported on all controllers
- Two controllers can support x8 link width
- Both 32- and 64-bit addressing
- 256-byte maximum payload size
- Full 64-bit decode with 40-bit wide windows
- Inbound INTx transactions
- Message signaled interrupt (MSI) transactions
- · One PCI Express controller supports end-point SR-IOV
 - Two physical functions, each with 64 virtual functions
 - Eight MSI-X per virtual function



5.9.2 Serial RapidIO

The Serial RapidIO interface is based on the *RapidIO Interconnect Specification, Revision 2.1*. RapidIO is a high-performance, point-to-point, low-pin-count, packet-switched system-level interconnect that can be used in a variety of applications as an open standard. The rich feature set includes high data bandwidth, low-latency capability, and support for high-performance I/O devices as well as message-passing and software-managed programming models. Receive and transmit ports operate independently, and with 2 x 4 Serial RapidIO controllers, the aggregate theoretical bandwidth is 32 Gbps.

The chip offers two Serial RapidIO controllers, muxed onto the SerDes blocks. The Serial RapidIO interface is based on the *RapidIO Interconnect Specification, Revision 2.1*. Receive and transmit ports operate independently and with 2 x 4 Serial RapidIO controllers; the aggregate theoretical bandwidth is 32 Gbps. The Serial RapidIO controllers can be used in conjunction with "Rapid IO Message Manager (RMAN), as described in RapidIO Message Manager (RMAn)."

Key features of the Serial RapidIO interface unit include the following:

- Support for RapidIO Interconnect Specification, Revision 2.1 (All transaction flows and priorities.)
- 2x, and 4x LP-serial link interfaces, with transmission rates of 2.5, 3.125, or 5.0 Gbaud (data rates of 1.0, 2.0, 2.5, or 4.0 Gbps) per lane
- Auto-detection of 1x, 2x, or 4x mode operation during port initialization
- 34-bit addressing and up to 256-byte data payload
- Support for SWRITE, NWRITE, NWRITE_R and Atomic transactions
- Receiver-controlled flow control
- RapidIO error injection
- · Internal LP-serial and application interface-level loopback modes

The Serial RapidIO controller also supports the following capabilities, many of which are leveraged by the RMan to efficient chip-to-chip communication through the DPAA:

- Support for RapidIO Interconnect Specification 2.1, "Part 2: Message Passing Logical Specification"
- Supports RapidIO Interconnect Specification 2.1, "Part 10: Data Streaming Logical Specification"
- Supports RapidIO Interconnect Specification 2.1, "Annex 2: Session Management Protocol"
 Supports basic stream management flow control (XON/XOFF) using extended header message format
- Up to 16 concurrent inbound reassembly operations
 - One additional reassembly context is reservable to a specific transaction type
- Support for outbound Type 11 messaging
- Support for outbound Type 5 NWRITE and Type 6 SWRITE transactions
- Support for inbound Type 11 messaging
- Support for inbound Type 9 data streaming transactions
- Support for outbound Type 9 data streaming transactions
 - Up to 64 KB total payload
- Support for inbound Type 10 doorbell transactions
 - Transaction steering through doorbell header classification
- Support for outbound Type 10 doorbell transactions
 - Ordering can be maintained with respect to other types of traffic.
- Support for inbound and outbound port-write transactions
 - Data payloads of 4 to 64 bytes

5.9.3 SATA

Each of the SoC's two SATA controllers is compliant with the *Serial ATA 2.6 Specification*. Each of the SATA controllers has the following features:

- Supports speeds: 1.5 Gbps (first-generation SATA), and 3Gbps (second-generation SATA)
- Supports advanced technology attachment packet interface (ATAPI) devices
- Contains high-speed descriptor-based DMA controller
- Supports native command queuing (NCQ) commands



5.10.1 Packet distribution and queue/congestion management

This table lists some packet distribution and queue/congestion management offload functions.

Table 3. Offload functions

Function type	Definition	
Data buffer management	Supports allocation and deallocation of buffers belonging to pools originally created by software with configurable depletion thresholds. Implemented in a module called the Buffer Manager (BMan).	
Queue management	Supports queuing and quality-of-service scheduling of frames to CPUs, network interfaces and DPAA logic blocks, maintains packet ordering within flows. Implemented in a module called the Queue Manager (QMan). The QMan, besides providing flow-level queuing, is also responsible for congestion management functions such as RED/WRED, congestion notifications and tail discards.	
Packet distribution	Supports in-line packet parsing and general classification to enable policing and QoS-based packet distribution to the CPUs for further processing of the packets. This function is implemented in the block called the Frame Manager (FMan).	
Policing	Supports in-line rate-limiting by means of two-rate, three-color marking (RFC 2698). Up to 256 policing profiles are supported. This function is also implemented in the FMan.	
Egress Scheduling	Supports hierarchical scheduling and shaping, with committed and excess rates. This function is supported in the QMan, although the FMan performs the actual transmissions.	

5.10.2 Accelerating content processing

Properly implemented acceleration logic can provide significant performance advantages over most optimized software with acceleration factors on the order of 10-100x. Accelerators in this category typically touch most of the bytes of a packet (not just headers). To avoid consuming CPU cycles in order to move data to the accelerators, these engines include well-pipelined DMAs. This table lists some specific content-processing accelerators on the chip.

Table 4.	Content-processing accelerators
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Interface	Definition	
SEC	Crypto-acceleration for protocols such as IPsec, SSL, and 3GPP RLC	
PME	Regex style pattern matching for unanchored searches, including cross-packet stateful patterns	
DCE	Compression/Decompression acceleration for ZLib and deflate	

5.10.3 Enhancements of T4240 compared to first generation DPAA

A short summary of T4240 enhancements over the first generation DPAA (as implemented in the P4080) is provided below:

- Frame Manager
 - 2x performance increase (up to 25 Gbps per FMan)
 - Storage profiles.
 - HiGig (3.125 GHz) and HiGig2 (3.125 GHz and 3.75 GHz)
 - Energy Efficient Ethernet
- SEC 5.0
 - 2x performance increase for symmetric encryption and protocol processing

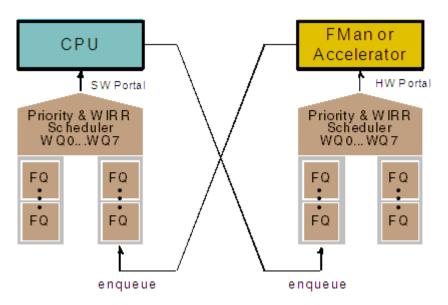


- Up to 20 Gbps for IPsec @ Imix
- 10x performance increase for public key algorithms
- Support for 3GPP Confidentiality and Integrity Algorithms 128-EEA3 & 128-EIA3 (ZUC)
- DCE 1.0, new accelerator for compression/decompression
- RMan (Serial RapidIO Manager)
- DPAA overall capabilities
 - Data Center Bridging
 - Egress Traffic Shaping

5.10.4 DPAA terms and definitions

The QorIQ Platform's Data Path Acceleration Architecture (henceforth DPAA) assumes the existence of network flows, where a flow is defined as a series of network datagrams, which have the same processing and ordering requirements. The DPAA prescribes data structures to be initialized for each flow. These data structures define how the datagrams associated with that flow move through the DPAA. Software is provided a consistent interface (the software portal) for interacting with hardware accelerators and network interfaces.

All DPAA entities produce data onto frame queues (a process called enqueuing) and consume data from frame queues (dequeuing). Software enqueues and dequeues through a software portal (each vCPU has two software portals), and the FMan, RMan, and DPAA accelerators enqueue/dequeue through hardware portals. This figure illustrates this key DPAA concept.





This table lists common DPAA terms and their definitions.

Table 5. DPAA terms and definitions

Term	Definition	Graphic representation
Buffer	Region of contiguous memory, allocated by software, managed by the DPAA BMan	в

Table continues on the next page ...



This figure is a logical view of the DPAA.

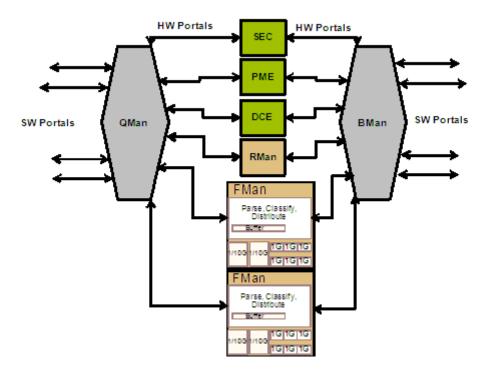


Figure 10. Logical representation of DPAA

5.10.5.1 Frame Manager and network interfaces

The chip incorporates two enhanced Frame Managers. The Frame Manager improves on the bandwidth and functionality offered in the P4080.

Each Frame Manager, or FMan, combines Ethernet MACs with packet parsing and classification logic to provide intelligent distribution and queuing decisions for incoming traffic. Each FMan supports PCD at 37.2 Mpps, supporting line rate 2x10G + 2x2.5G at minimum frame size.

These Ethernet combinations are supported:

- 10 Gbps Ethernet MACs are supported with XAUI (four lanes at 3.125 GHz) or XFI (one lane at 10.3125 GHz SerDes).
- 1 Gbps Ethernet MACs are supported with SGMII (one lane at 1.25 GHz with 3.125 GHz option for 2.5 Gbps Ethernet).
 - SGMIIs can be run at 3.125 GHz so long as the total Ethernet bandwidth does not exceed 25 Gbps on the associated FMan.
 - If not already assigned to SGMII, two MACs can be used with RGMII.
- Four x1Gbps Ethernet MACs can be supported using a single lane at 5 GHz (QSGMII).
- HiGig is supported using four lanes at 3.125 GHz or 3.75 GHz (HiGig2).

The Frame Manager's Ethernet functionality also supports the following:

- 1588v2 hardware timestamping mechanism in conjunction with IEEE Std. 802.3bf (Ethernet support for time synchronization protocol)
- Energy Efficient Ethernet (IEEE Std. 802.3az)
- IEEE Std. 802.3bd (MAC control frame support for priority based flow control)
- IEEE Std. 802.1Qbb (Priority-based flow control) for up to eight queues/priorities
- IEEE Std. 802.1Qaz (Enhanced transmission selection) for three or more traffic classes



Table 6.	Parser header types (continued)	

Header type	Definition	
	For example, a frame that always contains a proprietary header before the Ethernet header would be non-self-describing. Both self-describing and non-self-describing headers are supported by means of parsing rules in the FMan.	
Proprietary	Can be defined as being self-describing or non-self-describing	

The underlying notion is that different frames may require different treatment, and only through detailed parsing of the frame can proper treatment be determined.

Parse results can (optionally) be passed to software.

5.10.5.1.2 FMan distribution and policing

After parsing is complete, there are two options for treatment, as shown in this table.

Treatment	Function	Benefits
Hash		Useful when spreading traffic while obeying QoS constraints is required
Classification look-up	 Looks up certain fields in the frame to determine subsequent action to take, including policing. The FMan contains internal memory that holds small tables for this purpose. The user configures the sets of lookups to perform, and the parse results dictate which one of those sets to use. Lookups can be chained together such that a successful look-up can provide key information for a subsequent look-up. After all the look-ups are complete, the final classification result provides either a hash key to use for spreading, or a FQ ID directly. 	 Useful when hash distribution is insufficient and a more detailed examination of the frame is required Can determine whether policing is required and the policing context to use

Table 7. Post-parsing treatment options

Key benefits of the FMan policing function are as follows:

- Because the FMan has up to 256 policing profiles, any frame queue or group of frame queues can be policed to either drop or mark packets if the flow exceeds a preconfigured rate.
- Policing and classification can be used in conjunction to mitigate Distributed Denial of Service Attack (DDOS).
- The policing is based on the two-rate-three-color marking algorithm (RFC2698). The sustained and peak rates, as well as the burst sizes, are user-configurable. Therefore, the policing function can rate-limit traffic to conform to the rate that the flow is mapped to at flow set-up time. By prioritizing and policing traffic prior to software processing, CPU cycles can focus on important and urgent traffic ahead of other traffic.

Each FMan also supports PCD on traffic arriving from within the chip. This is referred to as off-line parsing, and it is useful for reclassification following decapsulation of encrypted or compressed packets.

FMan PCD supports virtualization and strong partitioning by delaying buffer pool selection until after classification. In addition to determining the FQ ID for the classified packet, the FMan also determines the 'storage profile.' Configuration of storage profiles (up to 32 per physical port) allows the FMan to store received packets using buffer pools owned by a single software partition, and enqueue the associated Frame Descriptor to a frame queue serviced by only that software partition.





- applies a dual-rate shaper to the aggregate of CR/ER frames from shaped channels
- can be configured (or reconfigured for lossless interface failover) to deliver frames to any network interface.
- Supports 32 channels available for allocation across the eight LNIs
- Each channel:
 - can be configured to deliver frames to any LNI.
 - can be configure to be unshaped or shaped; when shaped, a dual rate shaper applies to the aggregate of CR/ER frames from the channel.
 - has eight independent classes and eight grouped classes; grouped classes can be configured as one class group of eight or as two class groups of four.
 - supports weighted bandwidth fairness within grouped class groups with weights configured on a channel and class basis.
 - strict priority scheduling of the eight independent classes and the aggregate(s) of the grouped classe(s); the priority of each of the two class groups can be independently configured to be immediately below any of the independent classes.
 - is configurable such that each of the eight independent classes and two class groups can supply CR frames, ER frames or both when channel is configured to be shaped.
 - is configured independently.
- Each class:
 - has a dedicated class queue (CQ) with equivalent congestion management functionality available to FQs.
 - can have a dedicated or shared Congestion Management Record supports sufficient number of CMRs for all CQs to have a dedicated CMR, if desired.
 - can be flow-controlled by traffic-class flow control messages via portal; achieves backward compatibility with by allowing each of these 16 classes to be configured (per LNI) to respect one or none of the 8 on/off control bits within existing message format (as was defined for 8-class non-CEETM channels).
 - is identified via a "logical frame queue identifier" to maintain semantic compatibility with enqueue commands to frame queues (non-CEETM queues).
 - supports the identification of intra-class flows (logically equivalent to FQs but not queued separately) in order to apply static context (Context_A and Context_B) to frames as they are dequeued from CQs; this provides functionality equivalent to that available when a frame is dequeue from a frame queue (non-CEETM queues).

5.10.6.2.2 CEETM configuration

The CEETM configuration, shown in Figure 13, is very asymmetrical and is intended to demonstrate the degrees of configurability rather than an envisioned use case.

NOTE

The color green denotes logic units and signal paths that relate to the request and fulfillment of committed rate (CR) packet transmission opportunities. The color yellow denotes the same for excess rate (ER). The color black denotes logic units and signal paths that are used for unshaped opportunities or that operate consistently whether used for CR or ER opportunities.



Crip features

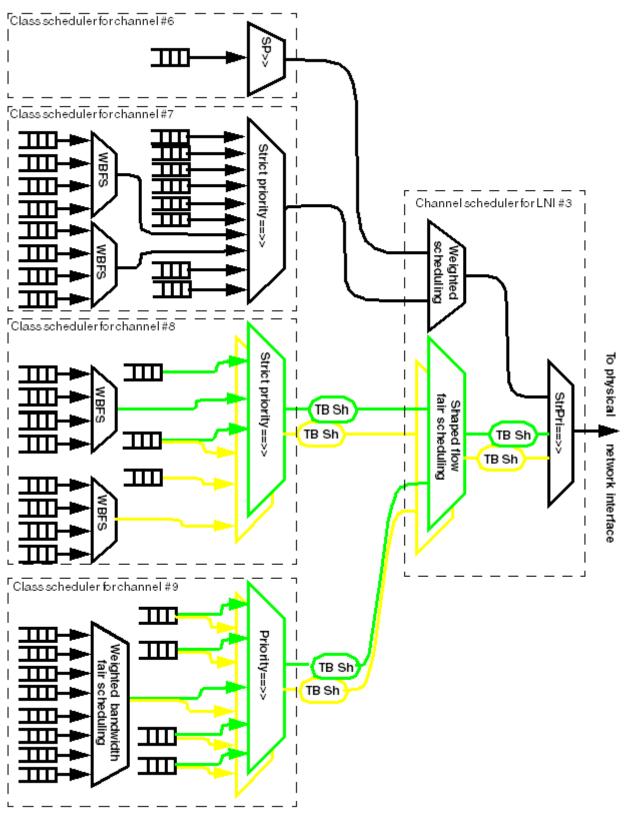




Figure 13 illustrates the following scenario:



- Channels #6, #7, #8 and #9 have been configured to be scheduled by the channel scheduler for LNI#3 (for example, all the packets from these channels are directed to the physical network interface configurably coupled to LNI#3).
- Channels #6 and #7 have been configured to be "unshaped." Packets from these channels will not be subjected to shaping at the channel level and will feed the top priority level within the LNI, which is also not subjected to shaping. Their class schedulers will not distinguish between CR and ER opportunities.
- Channels #8 and #9 have been configured to be "shaped." Their class schedulers will distinguish between CR and ER opportunities. The CR/ER packets to be sent from each channel shall be subjected to a pair of CR/ER token bucket shapers specific to that channel. The aggregate of CR/ER packets from these channels are subject to a pair of CR/ER token bucket shapers specific to LNI#3.
- Channel #6 has only one class in use. That class queue behaves as if it were a channel queue and as a peer to Channel #7. Unused classes do not have to be configured as such; they are simply not used.
- Channel #7 has all 16 classes in use.
 - The group classes have been configured as two groups (A and B) of four classes.
 - The priority of the groups A and B have both been set to be immediately below independent class 5. In a case of similar configuration group A has higher priority than group B.
- Channel #8 has three independent classes and two groups of four grouped classes in use.
 - The priorities of the class groups A and B have been set to be immediately below independent class 0 and class 2 respectively.
 - Independent class 0 and class group A have been configured to request and fulfill only CR packet opportunities.
 - Independent class 1 has been configured to request and fulfill both CR and ER packet opportunities.
 - Independent class 2 and class group B have been configured to request and fulfill only ER packet opportunities.
- Channels #9 has four independent classes and one group of eight grouped classes in use.
 - The group classes have been configured as one group (A) of eight classes.
 - All independent classes and the class group (A) have been configured to request and fulfill both CR and ER packet opportunities.

Benefits of the CEETM include the following:

- Provides "virtual" ports for multiple applications or users with different QoS/CoS requirements which are sharing an egress interface
- Supports DSCP capable scheduling for the following virtual link with configurable combinations of strict priority and weighted scheduling
 - Weighted scheduling closely approximating WFQ
- Supports traffic shaping
 - dual rate shaping of the virtual links
- Supports aggregating traffic from multiple virtual links and shaping this aggregate
- Hierarchical scheduling and shaping
- Class-based scheduling and dual rate shaping
- Supports a subset of the IEEE Data Center Bridging (DCB) standards

5.10.6.3 Data Center Bridging (DCB)

Data Center Bridging (DCB) refers to a series of inter-related IEEE specifications collectively designed to enhance Ethernet LAN traffic prioritization and congestion management. Although the primary objective is the data center environment (consisting of servers and storage arrays), some aspects of DCB are applicable to more general uses of Ethernet, within and between network nodes.

The SoC DPAA is compliant with the following DCB specifications :

- IEEE Std. 802.1Qbb: Priority-based flow control (PFC)
 - PAUSE frame per Ethernet priority code point (8)
 - Prevents single traffic class from throttling entire port
- IEEE Std. 802.1Qaz: Enhanced transmission selection (ETS)
 - Up to three Traffic Class Groups (TCG), where a TCG is composed of one or more priority code points
 - Bandwidth allocation and transmit scheduling (1% granularity) by traffic class group
 - If one of the TCGs does not consume its allocated bandwidth, unused bandwidth is available to other TCGs



5.12 Advanced power management

Power dissipation is always a major design consideration in embedded applications; system designers need to balance the desire for maximum compute and IO density against single-chip and board-level thermal limits.

Advances in chip and board level cooling have allowed many OEMs to exceed the traditional 30 W limit for a single chip, and Freescale's flagship T4240 multicore chip, has consequently retargeted its maximum power dissipation. A top-speed bin T4240 dissipates approximately 2x the power dissipation of the P4080; however, the T4240 increases computing performance by ~4x, yielding a 2x improvement in DMIPs per watt.

Junction temperature is a critical factor in comparing embedded processor specifications. Freescale specs max power at 105C junction, standard for commercial, embedded operating conditions. Not all multicore chips adhere to a 105C junction for specifying worst case power. In the interest of normalizing power comparisons, the chip's typical and worst case power (all CPUs at 1.8 GHz) are shown at alternate junction temperatures.

To achieve the previously-stated 2x increase in performance per watt, the chip implements a number of software transparent and performance transparent power management features. Non-transparent power management features are also available, allowing for significant reductions in power consumption when the chip is under lighter loads; however, non-transparent power savings are not assumed in chip power specifications.

5.12.1 Transparent power management

This chip's commitment to low power begins with the decision to fabricate the chip in 28 nm bulk CMOS. This process technology offers low leakage, reducing both static and dynamic power. While 28 nm offers inherent power savings, transistor leakage varies from lot to lot and device to device. Leakier parts are capable of faster transistor switching, but they also consume more power. By running devices from the leakier end of the process spectrum at less than nominal voltage and devices from the slower end of the process spectrum at higher nominal voltage, T4240-based systems can achieve the required operating frequency within the specified max power. During manufacturing, Freescale will determine the voltage required to achieve the target frequency bin and program this Voltage ID into each device, so that initialization software can program the system's voltage regulator to the appropriate value.

Dynamic power is further reduced through fine-grained clock control. Many components and subcomponents in the chip automatically sleep (turn off their clocks) when they are not actively processing data. Such blocks can return to full operating frequency on the clock cycle after work is dispatched to them. A portion of these dynamic power savings are built into the chip max power specification on the basis of impossibility of all processing elements and interfaces in the chip switching concurrently. The percent switching factors are considered quite conservative, and measured typical power consumption on QorIQ chips is well below the maximum in the data sheet.

As noted in Frame Manager and network interfaces, the chip supports Energy-Efficient Ethernet. During periods of extended inactivity on the transmit side, the chip transparently sends a low power idle (LPI) signal to the external PHY, effectively telling it to sleep.

Additional power savings can be achieved by users statically disabling unused components. Developers can turn off the clocks to individual logic blocks (including CPUs) within the chip that the system is not using. Based on a finite number of SerDes, it is expected that any given application will have some inactive Ethernet MACs, PCI Express, or serial RapidIO controllers. Re-enabling clocks to a logic block generally requires an chip reset, which makes this type of power management infrequent (effectively static) and transparent to runtime software.



5.12.2 Non-transparent power management

Many load-based power savings are use-case specific static configurations (thereby software transparent), and were described in the previous section. This section focuses on SoC power management mechanisms, which software can dynamically leverage to reduce power when the system is lightly loaded. The most important of these mechanisms involves the cores.

A full description of core low-power states with proper names is provided in the SoC reference manual. At a high level, the most important of these states can be viewed as "PH10" and "PH20," described as follows. Note that these are relative terms, which do not perfectly correlate to previous uses of these terms in Power Architecture and other ISAs:

- In PH10 state CPU stops instruction fetches but still performs L1 snoops. The CPU retains all state, and instruction fetching can be restarted instantly.
- In PH20 state CPU stops instruction fetches and L1 snooping, and turns off all clocks. Supply voltage is reduced, using a technique Freescale calls State Retention Power Gating (SRPG). In the "napping" state, a CPU uses ~75% less power than a fully operational CPU, but can still return to full operation quickly (~100 platform clocks).

The core offers two ways to enter these (and other) low power states: registers and instructions.

As the name implies, register-based power management means that software writes to registers to select the CPU and its low power state. Any CPU with write access to power management registers can put itself, or another CPU, into a low power state; however, a CPU put into a low power state by way of register write cannot wake itself up.

Instruction-based power management means that software executes special WAIT instruction to enter a low power state. CPUs exit the low power state in response to external triggers, interrupts, doorbells, stashes into L1-D cache, or clear reservation on snoop. Each vCPU can independently execute WAIT instructions; however, the physical CPU enters PH20 state after the second vCPU executes its wait. The instruction-based "enters PH20 state" state is particularly well-suited for use in conjunction with Freescale's patented Cascade Power Management, which is described in the next section.

While significant power savings can be achieved through individual CPU low power states, the SoC also supports a registerbased cluster level low power state. After software puts all CPUs in a cluster in a PH10 state, it can additionally flush the L2 cache and have the entire cluster enter PH20 state. Because the L2 arrays have relatively low static power dissipation, this state provides incremental additional savings over having four napping CPUs with the L2 on.

5.12.3 Cascade power management

Cascade power management refers to the concept of allowing SoC load, as defined by the depth of queues managed by the Queue Manager, to determine how many vCPUs need to be awake to handle the load. Recall from Queue Manager that the QMan supports both dedicated and pool channels. Pool channels are channels of frame queues consumed by parallel workers (vCPUs), where any worker can process any packet dequeued from the channel.

Cascade Power Management exploits the QMan's awareness of vCPU membership in a pool channel and overall pool channel queue depth. The QMan uses this information to tell vCPUs in a pool channel (starting with the highest numbered vCPU) that they can execute instructions to "take a nap." When pool channel queue depth exceeds configurable thresholds, the QMan wakes up the lowest numbered vCPU.

The SoC's dynamic power management capabilities, whether using the Cascade scheme or a master control CPU and load to power matching software, enable up to a 75% reduction to each corein power consumption versus data sheet max power.



Conclusion

5.13 Debug support

The reduced number of external buses enabled by the move to multicore chips greatly simplifies board level lay-out and eliminates many concerns over signal integrity. Even though the board designer may embrace multicore CPUs, software engineers have real concerns over the potential to lose debug visibility. Despite the problems external buses can cause for the hardware engineer, they provide software developers with the ultimate confirmation that the proper instructions and data are passing between processing elements.

Processing on a multicore chip with shared caches and peripherals also leads to greater concurrency and an increased potential for unintended interactions between device components. To ensure that software developers have the same or better visibility into the device as they would with multiple discrete communications processors, Freescale developed an Advanced Multicore Debug Architecture.

The debugging and performance monitoring capability enabled by the device hardware coexists within a debug ecosystem that offers a rich variety of tools at different levels of the hardware/software stack. Software development and debug tools from Freescale (CodeWarrior), as well as third-party vendors, provide a rich set of options for configuring, controlling, and analyzing debug and performance related events.

6 Conclusion

Featuring 24 virtual cores, and based on the dual-threaded e6500 Power Architecture core, the T4240 processor, along with its 16 (T4160) and 8 (T4080) virtual-core variants, offers frequencies up to 1.8 GHz, large caches, hardware acceleration, and advanced system peripherals. All three devices target applications that benefit from consolidation of control and data plane processing in a single chip. In addition, each e6500 core implements the Freescale AltiVec technology SIMD engine, dramatically boosting the performance of math-intensive algorithms without using additional DSP components on the board. A wide variety of applications can benefit from the processing, I/O integration, and power management offered for the T4 series processors. Similar to other QorIQ devices, the T4 family processors' high level of integration offers significant space, weight, and power benefits compared to multiple discrete devices. Freescale also offers fully featured development support, which includes the QorIQ T4240 QDS Development System, QorIQ T4240 Reference Design Board, Linux SDK for QorIQ Processors, as well as popular operating systems and development tools from a variety of vendors. See the Freescale website for the latest information on tools and SW availability.

For more information about the QorIQ T4 family, contact your Freescale sales representative.

Appendix A T4160

A.1 Introduction

The T4160 is a lower power version of the T4240. The T4160 combines eight dual threaded Power Architecture e6500 cores and two memory complexes (CoreNet platform cache and DDR3 memory controller) with the same high-performance datapath acceleration, networking, and peripheral bus interfaces.

This figure shows the major functional units within the chip.



Feature	T4240	T4160	
Max number of Anyspeed MACs configured for 10 GE operation	2 per Frame Manager	1 per Frame Manager	
SerDes and pinout			
Total number of SerDes lanes	4 x 8	2 x 4 and 2 x 8	
High-speed IO			
PCle	4	3 (PCIe 3 is disabled)	

Table A-1. Differences between T4240 and T4160 (continued)

Appendix B T4080

B.1 Introduction

The T4080 is a low power version of the T4160. The T4080 has four dual threaded Power Architecture e6500 cores with the same two memory complexes (CoreNet platform cache and DDR3 memory controller) with the same high-performance datapath acceleration, networking, and peripheral bus interfaces.

This figure shows the major functional units within the chip.



Rev. number	Date	Substantive change(s)
1	10/2014	 Added support for T4080 throughout document. Updated Introduction. In Summary of benefits, updated the first sentence to include "SDN switches or controllers, network function virtualization" and added the following subsections: e6500 CPU core Virtualization Data Path Acceleration Architecture (DPAA) System peripherals and networking In Intelligent network adapter, added examples. Updated Block diagram. In Features summary, added T4160 and T4080 thread specifications, added 10GBase-KR to the Ethernet interfaces, updated the coherent read bandwidth, and removed the note. In Critical performance parameters, removed the typical power consumption table. In Core and CPU clusters, updated the 16 way, set associative sub-bullets and changed the double-precision, full device value from "42.2" to "up to 42.4". Updated HiGig 2 in Enhancements of T4240 compared to first generation DPAA. Updated bullet two in CoreNet fabric and address map and updated the last bullet in Highspeed peripheral interface complex (HSSI). Updated Non-transparent power management. Rewrote Conclusion to add more information and a list of Freescale resources. In the Appendix A T4160 Introduction, removed the T4240-specific information.
0	06/2013	Initial public release.



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